Electronic Patent	App	lication Fee	Transm	ittal		
Application Number:	100	10067901				
Filing Date:	08-	08-Feb-2002				
Title of Invention:		Stretched film of void-containing thermoplastic resin and process for producing the same				
First Named Inventor/Applicant Name:	Tak	Takatoshi Nishizawa				
Filer:	Ma	Marvin Jay Spivak/Maritza Ulloa				
Attorney Docket Number:	218	218129US2				
Filed as Large Entity						
Utility under 35 USC 111(a) Filing Fees						
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)	
Basic Filing:						
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Post-Allowance-and-Post-Issuance:						
Extension-of-Time:						

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			1640